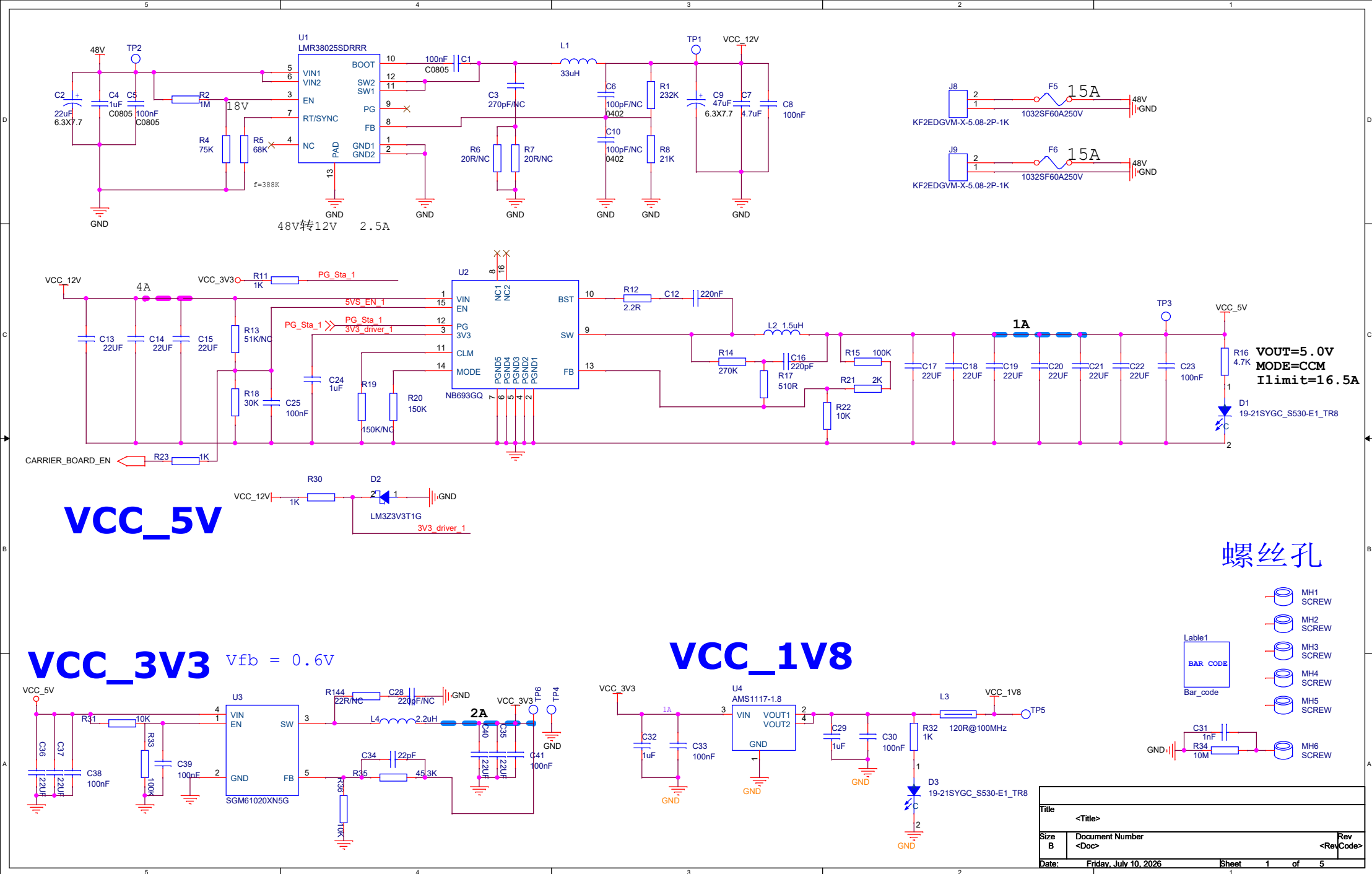
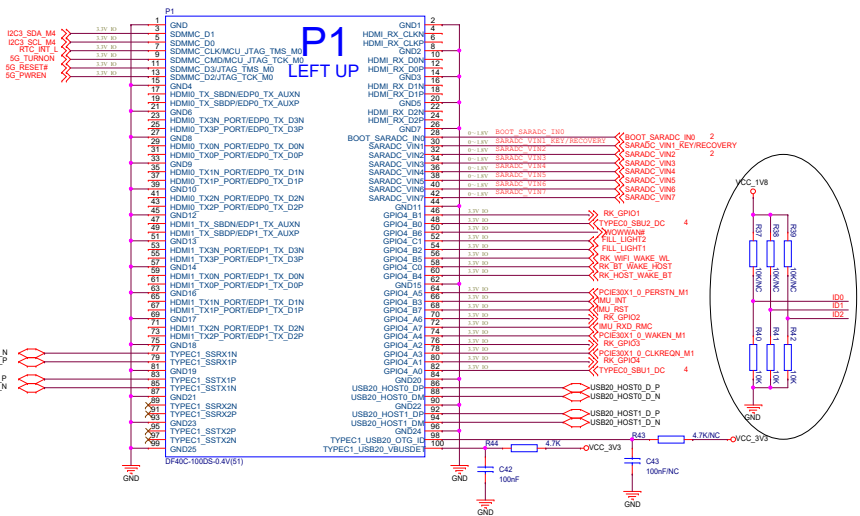
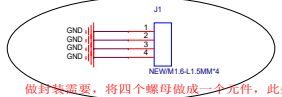
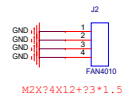
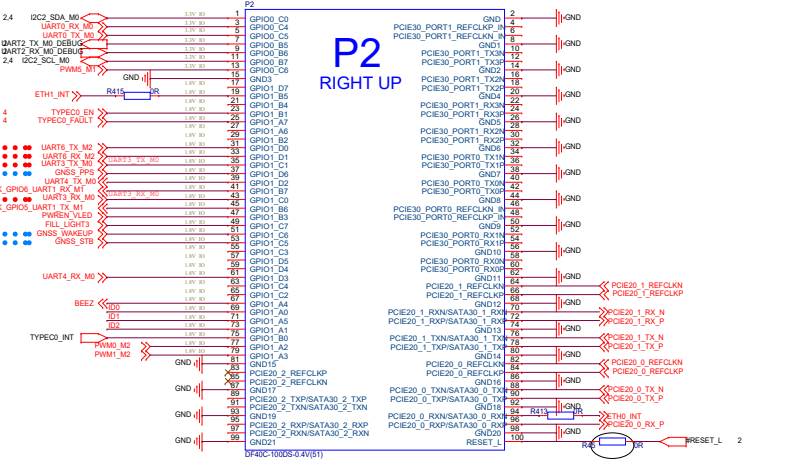




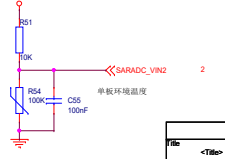
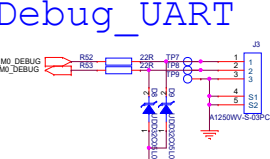
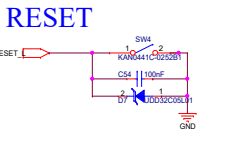
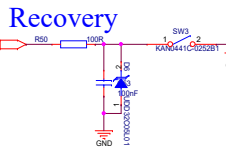
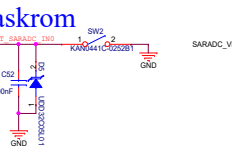
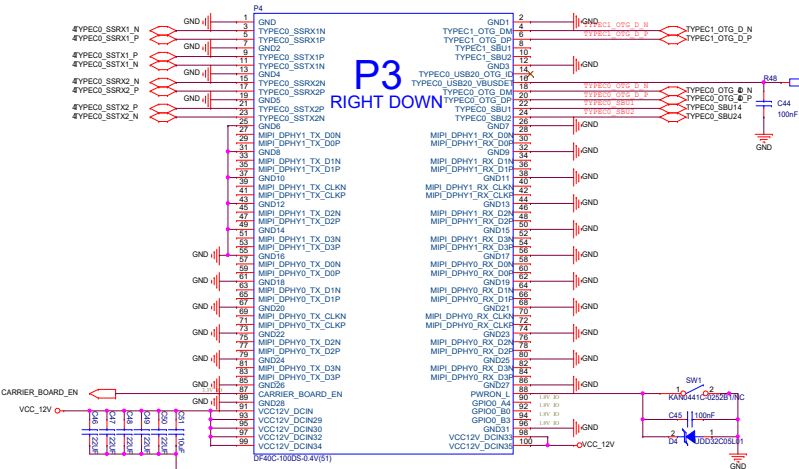
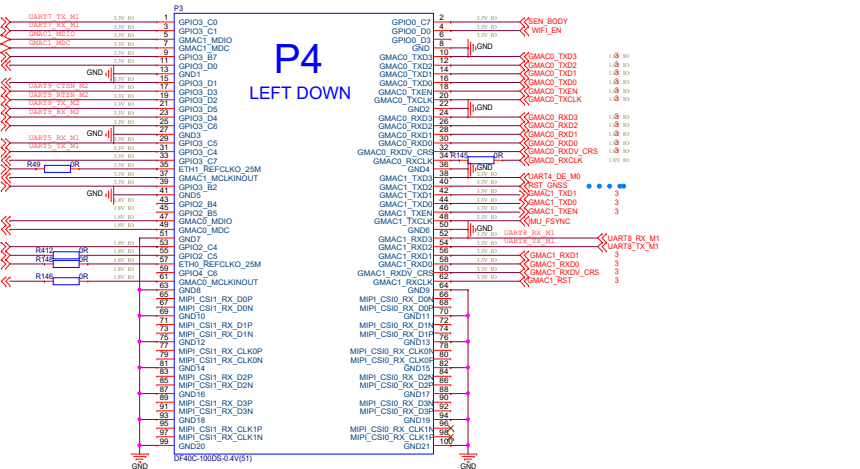


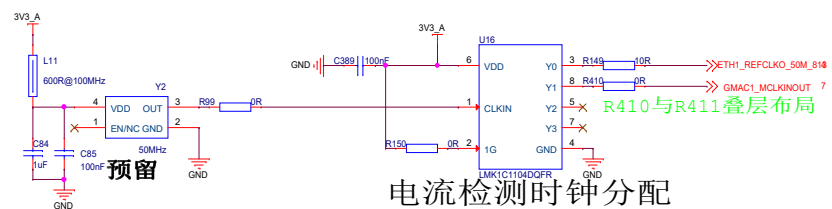
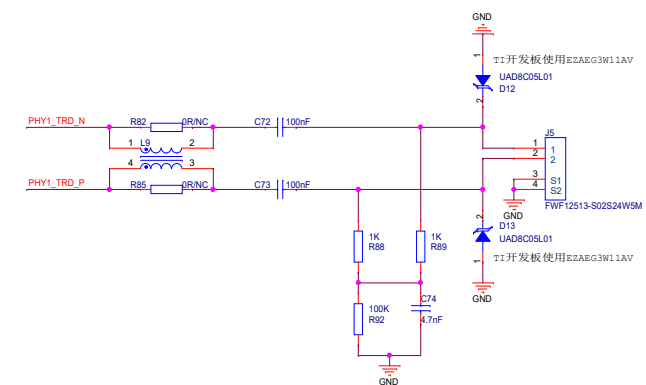
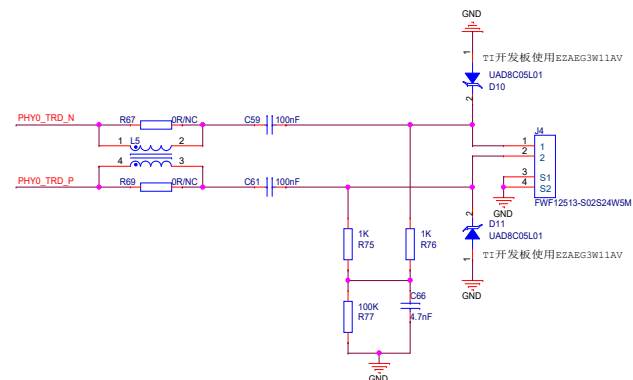
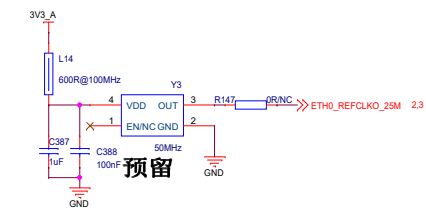
注意!!!

- 1、核心板所有引出信号均为静电敏感信号，HBM 耐受电压 $\geq 2000V$ ，CDM 耐受电压 $\geq 250V$
- 2、核心板运输、组装、使用过程中应做好静电防护
- 3、底板原理图设计时应对接口做好静电防护

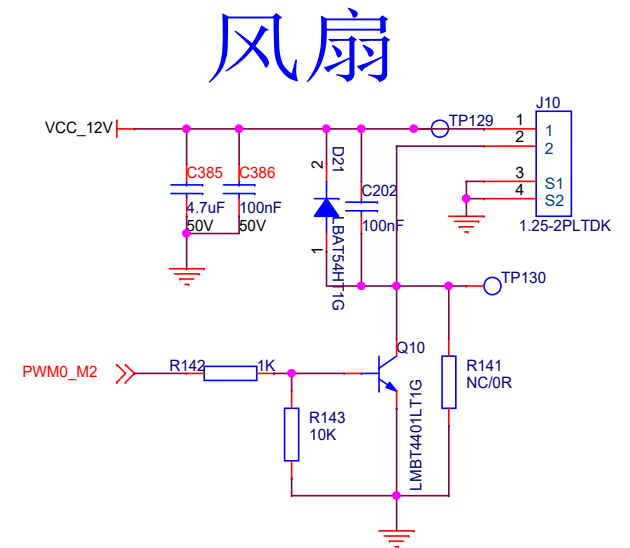
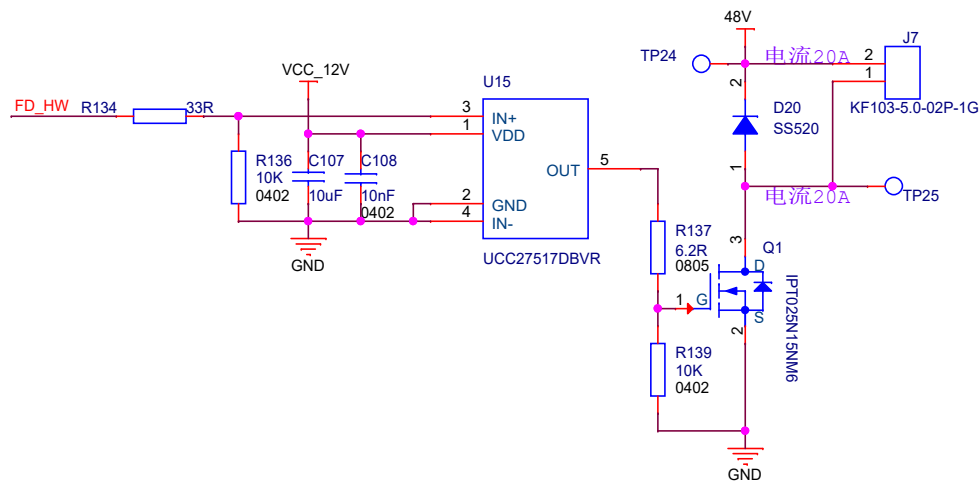
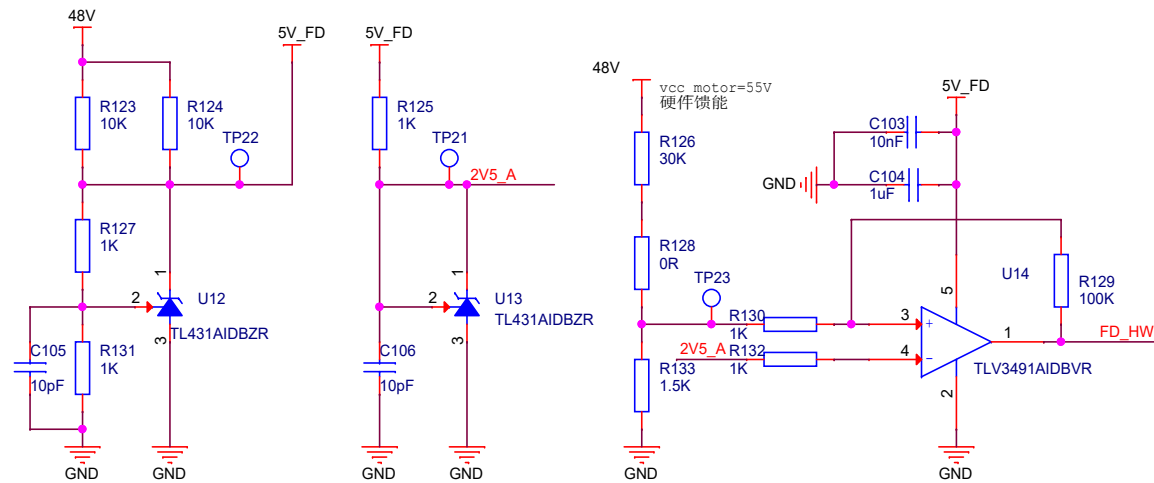


做封装需要，将四个螺母做成一个元件，此处需要手动在BOM里面增加





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